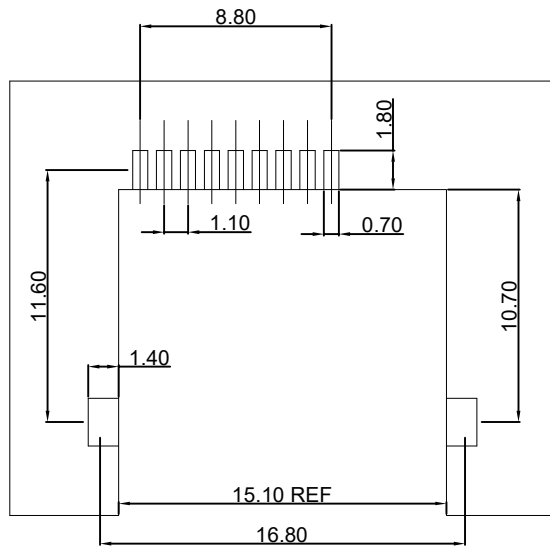
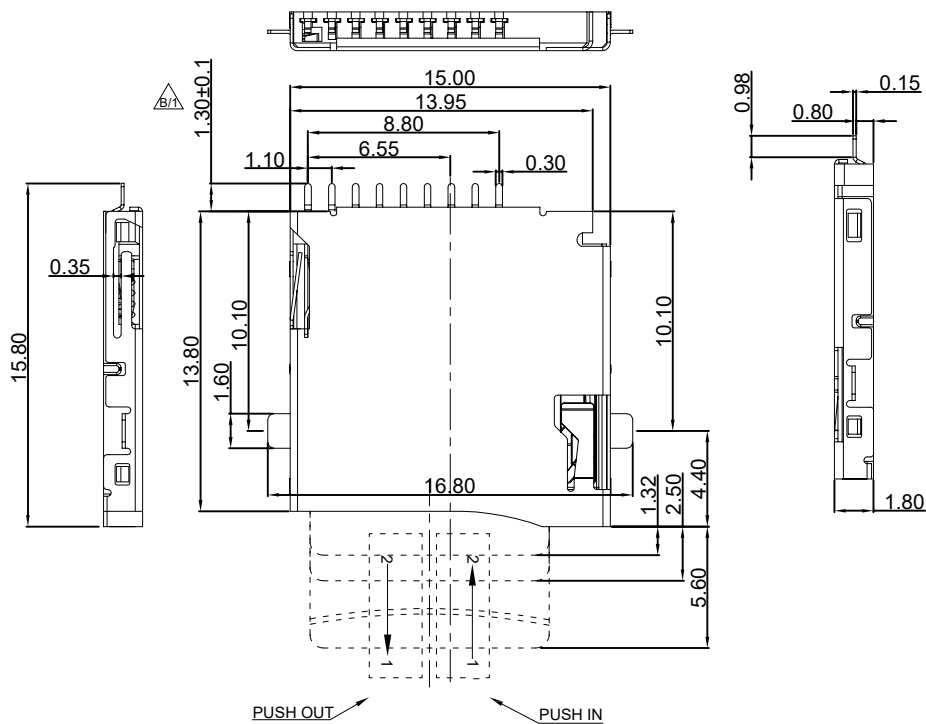


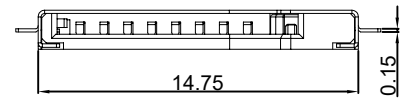
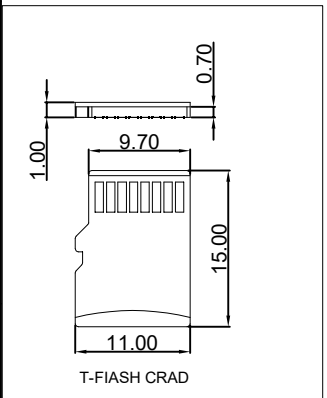
RoHS

REV	ECN NO.	DESCRIPTION	DESIGN	APPROVAL	DATE
A1	NEW	更换图框			2023.11.25



RECOMMENDED PCB HOLE LAYOUT
COMPONENT SIDE VIEW(TOLERANCE:±0.05)

- NOTES:
- MATERIAL:
HOUSING:HIGH TEMPERATURE THERMOPLASTIC
UL94V_0,COLOR:BLACK
CONTACT:COPPER ALLOYS.
COVER:SPEC
 - PLATING:
UNDERPLATE: NICKEL
CONTACT AREA: GOLD OVER NICKEL
SOLDER AREA: TIN OVER NICKEL
 - MULTIMEDIA CARD COMPATIBLE



PIN NO	NAME	YTPPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUOOLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DATO	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)

$X \pm 0.3$ $X^\circ \pm$
 $.X \pm 0.2$ $.X^\circ \pm$
 $.XX \pm 0.08$ $.XX^\circ \pm$
 $.XXX \pm 0.03$ $.XXX^\circ \pm$
 UNITS: mm

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PART NO: TFC6A-N1S1-2000-A		XFCN 兴飞连接器		
TITLE: 沉板0.8mm T-FLASH CRAD CONN		0769-82001899		
		www.xfconn.com		
		DWG NO: /		
APPD	Chen ZhiQiang	VIEW		
CHKD	Liu Wei	SCALE	SHEET	REV
DRAW	Chen HongJiang			
DATE	2024.08.19	NONE	1/2	A1